

# INTERNATIONAL STANDARD

# NORME INTERNATIONALE



**Universal serial bus interfaces for data and power –  
Part 2-2: Micro-USB Cables and Connectors Specification, Revision 1.01**

**Interfaces de bus universel en série pour les données et l'alimentation électrique –  
Partie 2-2: Spécification des câbles et connecteurs micro-USB, révision 1.01**

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**UNIVERSAL SERIAL BUS INTERFACES  
FOR DATA AND POWER –****Part 2-2: Micro-USB Cables and  
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The text of this standard is based on documents prepared by the USB Implementers Forum (USB-IF). The structure and editorial rules used in this publication reflect the practice of the organization which submitted it.

This first edition cancels and replaces IEC 62680-2 published in 2013. This edition constitutes a technical revision.

This bilingual version (2018-05) corresponds to the English version, published in 2015-09.

The text of this standard is based on the following documents:

CDV	Report on voting
100/2332/CDV	100/2435/RVC

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

The French version of this standard has not been voted upon.

A list of all the parts in the IEC 62680 series, published under the general title *Universal serial bus interfaces for data and power* can be found on the IEC website.

The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the IEC website under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

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This series covers the Universal Serial Bus interfaces for data and power and consists of the following parts:

IEC 62680-1-1, *Universal Serial Bus interfaces for data and power – Part 1-1: Common components – USB Battery Charging Specification, Revision 1.2*

IEC 62680-2-1, *Universal Serial Bus interfaces for data and power – Part 2-1: Universal Serial Bus Specification, Revision 2.0*

IEC 62680-2-2, *Universal Serial Bus interfaces for data and power – Part 2-2: USB Micro-USB Cables and Connectors Specification, Revision 1.01*

IEC 62680-2-3, *Universal Serial Bus interfaces for data and power – Part 2-3: Universal Serial Bus Cables and Connectors Class Document Revision 2.0*

This part of the IEC 62680 series consists of several distinct parts:

- the main body of the text, which consists of the original specification and all ECN and Errata developed by the USB-IF.

## CONTENTS

FOREWORD.....	2
INTRODUCTION.....	4
1 Introduction .....	10
1.1 General.....	10
1.2 Objective of the Specification.....	10
1.3 Intended Audience/Scope .....	10
1.4 Related Documents.....	10
2 Acronyms and Terms.....	10
3 Significant Features.....	11
3.1 USB 2.0 Specification Compliance .....	11
3.2 On-The-Go Device .....	12
3.3 Connectors .....	12
3.4 Compliant Cable Assemblies.....	12
3.5 Plug Overmolds .....	12
4 Cables and Connectors .....	13
4.1 Introduction.....	13
4.2 Micro-Connector Mating.....	13
4.3 Color Coding.....	13
4.4 Device, Cable and Adapter Delays.....	14
4.5 Compliant Usage of Connectors and Cables.....	15
4.5.1 Cables.....	15
4.5.2 Overmolds.....	15
4.5.3 Mechanical Interfaces.....	15
4.5.4 Surface mount standard version drawings.....	15
4.5.5 DIP-type and Midmount-type receptacles.....	15
4.5.6 Connector Keying .....	15
4.5.7 Right Angle Plugs.....	15
4.5.8 Adapters.....	16
4.6 Drawings.....	17
5 Electrical Compliance Requirements.....	35
5.1 Data Rates Beyond USB 2.0 (480 Mb/s -->) .....	36
5.2 Low Level Contact Resistance .....	36
5.3 Contact Current Rating .....	36
5.3.1 Signal Contacts Only (2, 3, and 4) .....	36
5.3.2 With Power Applied Contacts (1 and 5).....	36
6 Mechanical Compliance Requirements .....	36
6.1 Operating Temperature Range.....	36
6.1.1 Option I .....	36
6.1.2 Option II .....	36
6.2 Insertion Force.....	36
6.3 Extraction Force.....	36
6.4 Plating .....	37
6.4.1 Option I .....	37
6.4.2 Option II .....	37

6.5	Solderability .....	37
6.6	Peel Strength (Reference Only) .....	37
6.7	Wrenching Strength (Reference Only) .....	37
6.8	Lead Co-Planarity .....	37
6.9	RoHS Compliance .....	37
6.10	Shell & Latch Materials .....	38
Figure 4-1	– Micro-A to Micro-B Cable .....	17
Figure 4-2	– Standard-A to Micro-B Cable .....	18
Figure 4-3	– Micro-A to Captive Cable .....	19
Figure 4-4	– Micro-A Plug Overmold, Straight .....	20
Figure 4-5	– Micro-B Plug Overmold, Straight .....	21
Figure 4-6	– Micro-A Plug Interface .....	22
Figure 4-7	– Micro-B Plug Interface .....	23
Figure 4-8	– Micro-A/B Plug Interface (Cut-section) .....	24
Figure 4-9	– Micro-AB receptacle interface .....	25
Figure 4-10	– Micro-B receptacle interface .....	26
Figure 4-11	– Micro-AB Receptacle Design .....	27
Figure 4-12	– Micro-B Receptacle Design .....	28
Figure 4-13	– Micro-A Plug Blockage .....	29
Figure 4-14	– Micro-B Plug Blockage .....	30
Figure 4-15	– Micro-A Plug, Side Right Angle .....	31
Figure 4-16	– Micro-A Plug, Down Right Angle .....	32
Figure 4-17	– Micro-B Plug, Side Right Angle .....	33
Figure 4-18	– Micro-B Plug, Down Right Angle .....	34
Figure 4-19	– Adapter, Standard-A receptacle to Micro-A plug .....	35
Figure 4-9	– Micro-AB receptacle interface .....	40
Figure 4-10	– Micro-B receptacle interface .....	41
Table 4-1	– Plugs Accepted By Receptacles .....	13
Table 4-2	– Micro-A Plug Pin Assignments .....	13
Table 4-3	– Color Coding for Plugs and Receptacles .....	14
Table 4-4	– Maximum Delay for Micro-Connector and Cable .....	14
Table 4-5	– Maximum Delay for Standard Connector Cable .....	14

**Note: All Engineering Change Notice’s (ECN) and Errata documents as of September 01, 2012 that pertain to this core specification follow the last page of the specification starting on page 39.**



## Universal Serial Bus Micro-USB Cables and Connectors Specification

Revision 1.01  
 April 4, 2007

### Revision History

Revision	Issue Date	Comment
0.6	1/30/2006	Revisions to all sections
0.7	3/24/2006	Added revised Micro-USB drawings to Rev.0.8
0.8	4/19/2006	Editorial changes and additions by Jan Fahlund (Nokia)
0.8b	4/26/2006	Corrections to the 0.8 version (based by comments from contributors)
0.9	6/7/2006	Corrections based on comments from the 0.8b version
1.0RC	8/2/2006	Added lubricant recommendation, LLRC delta change specified
1.01RC	11/10/2006	Editorial changes and addition based on Oct-06 USB-IF CCWG meeting.
1.02RC	12/10/2006	Shell material thickness tolerances changed so that material can be 0.25 mm or 0.3 mm; edited three pictures (Figure 4-10, 4-11 and 4-12).
1.03RC	12/11/2006	Two pictures edited (Figure 4-8 and 4-9). In fig 4-8 max height to be 2.8 mm MAX. In fig 4-9 R0.25 mm MAX to be R0.30 mm MAX.
1.0RC3	12/19/2006	For BoD approval
1.0	1/12/2007	Approved
1.0	1/22/2007	Cosmetic edits for publication
1.01	4/4/2007	Editorial corrections and additions to contributor list. Reinserted shell and plug material requirements as section 6.10; Clarified wording on Plating Recommendations.

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# UNIVERSAL SERIAL BUS INTERFACES FOR DATA AND POWER –

## Part 2-2: Micro-USB Cables and Connectors Specification, Revision 1.01

### 1 Introduction

#### 1.1 General

USB has become a popular interface for exchanging data between cell phone and portable devices. Many of these devices have become so small it is impossible to use standard USB components as defined in the USB 2.0 specification. In addition the durability requirements of the Cell Phone and Portable Devices market exceed the specifications of the current interconnects. Since Cell Phones and other small Portable Devices are the largest market potential for USB, this specification is addressing this very large market while meeting all the requirements for electrical performance within the USB 2.0 specification.

#### 1.2 Objective of the Specification

The purpose of this document is to define the requirements and features of a Micro-USB connector that will meet the current and future needs of the Cell Phone and Portable Devices markets, while conforming to the USB 2.0 specification for performance, physical size and shape of the Micro-USB interconnect.

This is not a stand-alone document. Any aspects of USB that are not specifically changed by this specification are governed by the USB 2.0 Specification and USB On-The-Go Supplement.

#### 1.3 Intended Audience/Scope

Cell phone and Portable Devices have become so thin that the current Mini-USB does not fit well within the constraints of future designs. Additional requirements for a more rugged connector that will have durability past 10 000 cycles and still meet the USB 2.0 specification for mechanical and electrical performance was also a consideration. The Mini-USB could not be modified and remain backward compatible to the existing connector as defined in the USB OTG specification.

#### 1.4 Related Documents

USB 2.0

USB OTG Supplement

### 2 Acronyms and Terms

This chapter lists and defines terms and abbreviations used throughout this specification.

**A-Device** A device with a Type-A plug inserted into its receptacle. The A-device supplies power to VBUS and is host at the start of a session. If the A-device is On-The-Go, it may relinquish the role of host to an On-The-Go B-device under certain conditions,

<b>Application</b>	A generic term referring to any software that is running on a device that can control the behavior or actions of the USB port(s) on a device.
<b>B-Device</b>	A device with a Type-B plug inserted into its receptacle. The B-device is a peripheral at the start of a session. If the B-device is OTG, it may be granted the role of host from an OTG A-device.
<b>DIP-type</b>	A connector with contact and shield solder tails that are soldered through the printed circuit board.
<b>FS</b>	Full Speed (max 12 Mb/s)
<b>Higher than HS</b>	(480 Mb/s ---> 5 Gb/s)
<b>HS</b>	High Speed (max 480 Mb/s)
<b>Host</b>	A physical entity that is attached to a USB cable and is acting in the role of the USB host as defined in the USB Specification, Revision 2.0. This entity initiates all data transactions and provides periodic Start of Frames.
<b>HNP</b>	Host Negotiation Protocol
<b>ID</b>	Identification. Denotes the pin on the Micro connectors that is used to differentiate a Micro-A plug from a Micro-B plug.
<b>LS</b>	Low Speed (max 1,5 Mb/s)
<b>Midmount-type</b>	A connector that is mounted in a cut-out in the printed circuit board between the top and bottom surfaces.
<b>OTG</b>	On-The-Go
<b>OTG device</b>	A device with the host and peripheral capabilities
<b>Peripheral</b>	A physical entity that is attached to a USB cable and is currently operating as a “device” as defined in the USB Specification, Revision 2.0. The Peripheral responds to low level bus requests from the Host.
<b>PCB</b>	Printed circuit board
<b>USB</b>	Universal Serial Bus
<b>USB-IF</b>	USB Implementers Forum

### 3 Significant Features

This section identifies the significant features of the Micro-USB specification. The purpose of this section is not to present all the technical details associated with each major feature, but rather to highlight its existence. Where appropriate, this section references other parts of the document where further details can be found.

#### 3.1 USB 2.0 Specification Compliance

Any device with Micro-USB features is first and foremost a USB peripheral that is compliant with the USB 2.0 specification.

### 3.2 On-The-Go Device

Any OTG Micro-USB device shall conform to the OTG requirements as set forth in the On-The-Go Supplement to the USB 2.0 Specification.

### 3.3 Connectors

The USB 2.0 specification defines the following connectors:

- Standard-A plug and receptacle,
- Standard-B plug and receptacle, and
- Mini-B plug and receptacle.

The Micro-USB specification defines the following additional connectors:

- Micro-B plug and receptacle
- Micro-AB receptacle
- Micro-A plug.

The Micro-AB receptacle is only allowed on OTG products. All other uses of the Micro-AB receptacle are prohibited. The Micro-AB receptacle accepts either a Micro-A plug or a Micro-B plug.

It is recommended that the Micro-AB continue to support HNP as requested and support full functionality as a peripheral when a Micro-B plug is inserted.

### 3.4 Compliant Cable Assemblies

The USB 2.0 specification defines the following cables:

- Standard-A plug to Standard-B plug,
- Standard-A plug to Mini-B plug, and
- Captive cable with Standard-A plug.

The Micro-USB specification defines the following additional cables:

- Micro-A plug to Micro-B plug,
- Micro-A plug to Standard-A receptacle
- Micro-B plug to Standard-A plug, and
- Hardwired Captive cable with Micro-A plug. (Hardwired Captive cable is a cable, connected internally to a device, which is not designed to be removed by the end user of that device.)

No other types of cables are allowed by either the USB specification, or by the OTG supplement. Cables are not allowed to have receptacles on either end unless they meet the mechanical and electrical requirements of adapters defined in this document.

### 3.5 Plug Overmolds

The Micro-USB specification constrains the size and the shape of the overmolds for the Micro-A and Micro-B plugs.

The Micro-A plug's overmold has a rectangular shape, and the Micro-B plug's overmold is rectangular with chamfers. This allows easy recognition and differentiation of the two plugs by the consumer. See pictures Figure 4-4 and Figure 4-5.

## 4 Cables and Connectors

### 4.1 Introduction

This chapter provides the mechanical and electrical specifications for the cables, connectors and cable assemblies used to interconnect devices as well as constraints on the design of the overmolds for the Micro-A and Micro-B plugs.

### 4.2 Micro-Connector Mating

The following table summarizes the plugs accepted by each of the receptacles.

**Table 4-1 – Plugs Accepted By Receptacles**

Receptacle	Plugs Accepted
Standard-A	Standard-A
Standard-B	Standard-B
Mini-B	Mini-B
Micro-B	Micro-B
Micro-AB	Micro-A or Micro-B

The usage and wiring assignments of the five pins in the Micro-A plug are defined in the following table.

**Table 4-2 – Micro-A Plug Pin Assignments**

Contact Number	Signal Name	Typical Wiring Assignment
1	VBUS	Red
2	D-	White
3	D+	Green
4	ID	<Ra_PLUG_ID
5	GND	Black
Shell	Shield	Drain Wire

The ID pin on a Micro-A plug shall be connected to the GND pin. The ID pin on a Micro-B plug is not connected or is connected to ground by a resistance of greater than Rb\_PLUG\_ID (100 kΩ MIN). An On-The-Go device is required to be able to detect whether a Micro-A or Micro-B plug is inserted by determining if the ID pin resistance to ground is less than Ra\_PLUG\_ID (10 Ω MAX) or if the resistance to ground is greater than Rb\_PLUG\_ID. Any ID resistance less than Ra\_PLUG\_ID shall be treated as ID = FALSE and any resistance greater than Rb\_PLUG\_ID shall be treated as ID = TRUE.

### 4.3 Color Coding

The following colors are mandated for the plastic inside the Micro-USB connectors defined in this specification.